# Dual N-Channel 60 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	60			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 V$	0.033			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 4.5 V$	0.045			
I <sub>D</sub> (A) per leg	7			
Configuration	Dual			

### **FEATURES**

- Trench power MOSFET
- 100 %  $\rm R_g$  and UIS tested







(1) Tr1 Source (2) Tr1 Gate (3) Tr2 Drain (4) Tr2 Source	*2		*1  +  +			
(4) Tr2 Source	۰° ا	6	6			
(5) Tr2 Gate	(1)	(2)	(3)			
(6) Tr1 Drain		*1 ESD PROTECTION DIOD *2 BODY DIODE				

(6)

(5)

(4)

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \text{ °C}$ , unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	60	v	
Gate-Source Voltage		V <sub>GS</sub>	± 20	v	
Continuous Drain Current	T <sub>C</sub> = 25 °C	I.	7		
	T <sub>C</sub> = 125 °C		4		
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	3.6	А	
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	28		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	18		
Single Pulse Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>	16.2	mJ	
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	P <sub>D</sub>	4	W	
	T <sub>C</sub> = 125 °C	۳D	1.3		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount <sup>c</sup>	R <sub>thJA</sub>	110	°C/W	
Junction-to-Foot (Drain)		R <sub>thJF</sub>	34	0/10	

#### Notes

a. Package limited.

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

c. When mounted on 1" square PCB (FR4 material).



## **VBI3638**

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<b>SPECIFICATIONS</b> ( $T_C = 25 \text{ °C}$ , unless otherwise noted)								
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$		60	-	-	v	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	1.5	2.0	2.5	v	
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	$0 \text{ V}, \text{V}_{\text{GS}} = \pm 20 \text{ V}$	-	-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V	-	-	1	μA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50		
		$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	150		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = 10 \text{ V}$	$V_{DS} \ge 5 V$	20	-	-	А	
		$V_{GS} = 10 \text{ V}$	I <sub>D</sub> = 4.5 A	-	0.033	-	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 4.5 A, T <sub>J</sub> = 125 °C	-	0.066	-		
	DO(OII)	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 4.5 A, T <sub>J</sub> = 175 °C	-	0.081	-		
		$V_{GS} = 4.5 V$	$I_D = 4 A$	-	0.045	-		
Forward Transconductance <sup>f</sup>	9fs	V <sub>DS</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 4.5 \text{ A}$		15	-	S	
Dynamic <sup>b</sup>	-			1	1	1	1	
Input Capacitance	C <sub>iss</sub>			-	600	750		
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	$V_{GS} = 0 \text{ V} \qquad V_{DS} = 25 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	110	140	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	50	62		
Total Gate Charge <sup>c</sup>	Qg			-	11.7	18		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$	0 V $V_{DS} = 30 \text{ V}, \text{ I}_{D} = 5.3 \text{ A}$	-	1.8	2.7	nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			-	2.8	4.2		
Gate Resistance	Rg		f = 1 MHz		-	6	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>		V <sub>DD</sub> = 30 V, R <sub>I</sub> = 6.8 Ω		7	11		
Rise Time <sup>c</sup>	t <sub>r</sub>	V <sub>DD</sub> =			3.3	5	- ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 4.4$ A, $V_{GEN} = 10$ V, $R_g = 1 \Omega$		-	22.4	33.5		
Fall Time <sup>c</sup>	t <sub>f</sub>			-	2.1	3.2		
Source-Drain Diode Ratings and Chara	acteristics <sup>b</sup>				•			
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	28	Α	
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> = 2 A, V <sub>GS</sub> = 0 V		-	0.75	1.1	V	
2		, , , , ,		1	1	1	1	

Notes

a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.
c. Independent of operating temperature.

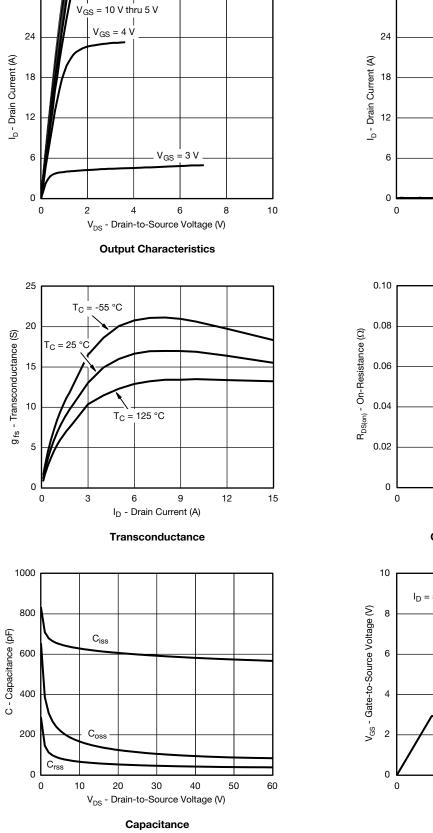
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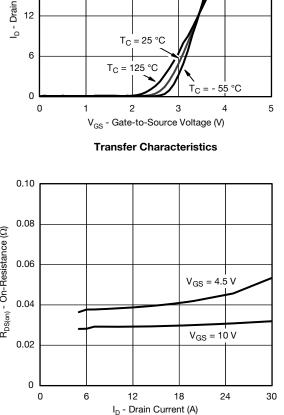
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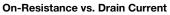


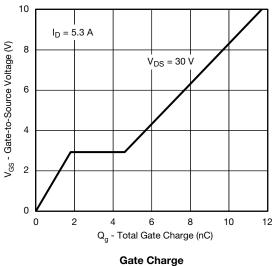
## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



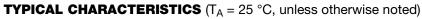


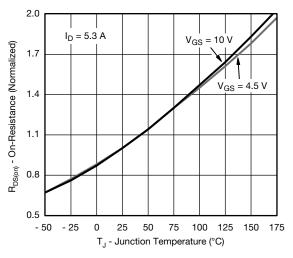
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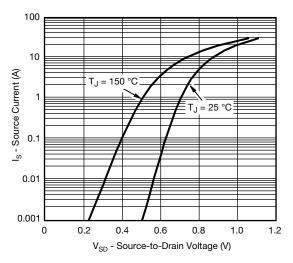




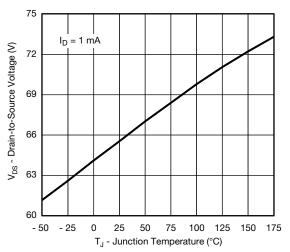




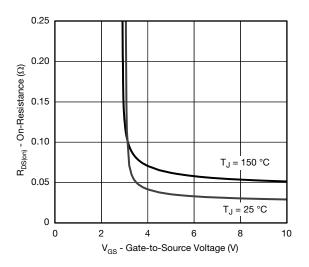
**On-Resistance vs. Junction Temperature** 



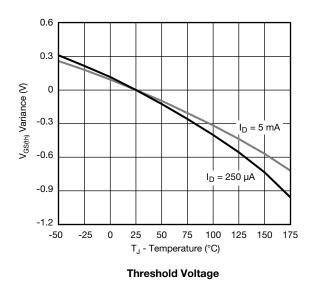
Source Drain Diode Forward Voltage



Drain Source Breakdown vs. Junction Temperature

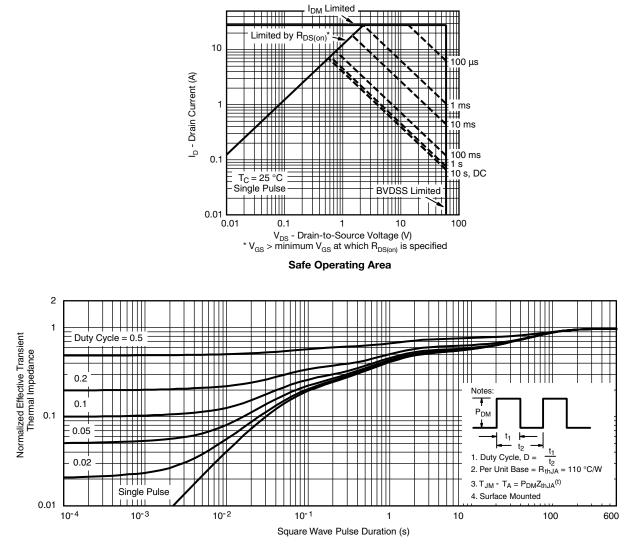


On-Resistance vs. Gate-to-Source Voltage



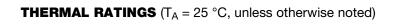


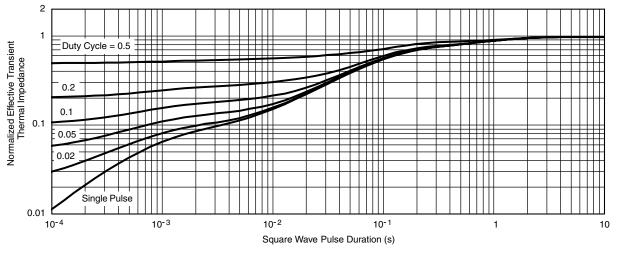
## **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient







Normalized Thermal Transient Impedance, Junction-to-Foot



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